Stress Effects CoCr₂O₄ Film on MgO and MgAl₂O₄ Grown by RF-Sputter Process

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(Received 10 November 2008, Received in final form 1 December 2008, Accepted 4 December 2008)

Multiferroic CoCr₂O₄ film was deposited on MgO and MgAl₂O₄ substrates by the rf-sputtering process. The films were prepared at an RF-magnetron sputtering power of 50 W and a pressure of 10 mtorr (20 sccm in Ar), and at substrate temperatures of 550 °C. The crystal structure was determined to be a spinel (Fd-3m) structure by means of X-ray diffraction (XRD) with Cu K¥á radiation. The thickness and morphology of the films were measured by scanning electron microscopy (SEM) and atomic force microscopy (AFM). The magnetic properties were measured using a Superconducting Quantum Interference Device (SQIUD) magnetometer. While the ferrimagnetic transitions were observed at about 93 K, which was determined as the Néel temperature, the magnetic properties all show different behaviors. The differences between the magnetic properties can be explained by the stress effects between CoCr₂O₄ and the substrates of MgO and MgAl₂O₄.

Keywords: multiferroic, RF sputtering